



FRAF801G - FRAF807G

Isolated 8.0 AMPS. Glass Passivated
Fast Recovery Rectifiers

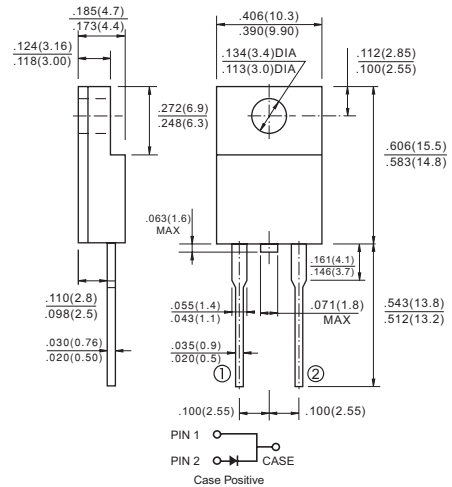
ITO-220AC

Features

- ✧ Glass passivated chip junction.
- ✧ High efficiency, Low VF
- ✧ High current capability
- ✧ High reliability
- ✧ High surge current capability
- ✧ Low power loss

Mechanical Data

- ✧ Cases: ITO-220AC molded plastic
- ✧ Epoxy: UL 94V-0 rate flame retardant
- ✧ Terminals: Pure tin plated, Lead free. Leads solderable per MIL-STD-202, Method 208 guaranteed
- ✧ Polarity: As marked
- ✧ High temperature soldering guaranteed: 260 °C /10 seconds 0.25", (6.35mm) from case.
- ✧ Mounting position: Any
- ✧ Weight: 2.24 grams
- ✧ Mounting torque: 5 in – 1bs. max.



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25 °C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbol	FRAF 801G	FRAF 802G	FRAF 803G	FRAF 804G	FRAF 805G	FRAF 806G	FRAF 807G	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @ $T_C = 55^\circ\text{C}$	$I_{(AV)}$	8.0							A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	150							A
Maximum Instantaneous Forward Voltage @ 8.0A	V_F	1.3							V
Maximum DC Reverse Current @ $T_C=25^\circ\text{C}$ at Rated DC Blocking Voltage @ $T_C=125^\circ\text{C}$	I_R	5.0 100							μA μA
Maximum Reverse Recovery Time (Note 2)	T_{rr}	150				250	500		nS
Typical Junction Capacitance (Note 1) $T_J=25^\circ\text{C}$	C_j	50							pF
Typical Thermal Resistance (Note 3)	$R_{\theta JC}$	5.0							$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150							$^\circ\text{C}$

Notes:

1. Measured at 1 MHz and Applied Reverse Voltage of 4.0 Volts D.C.
2. Reverse Recovery Test Conditions: $I_F=0.5\text{A}$, $I_R=1.0\text{A}$, $I_{RR}=0.25\text{A}$
3. Thermal Resistance from Junction to Case, with Heatsink size 2" x 3" x 0.25" Al-Plate.

RATINGS AND CHARACTERISTIC CURVES (FRAF801G THRU FRAF807G)

FIG.1- MAXIMUM FORWARD CURRENT DERATING CURVE

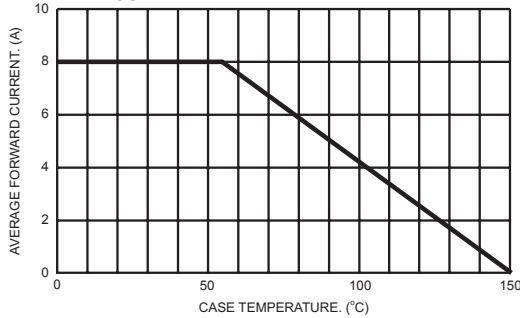


FIG.2- TYPICAL REVERSE CHARACTERISTICS

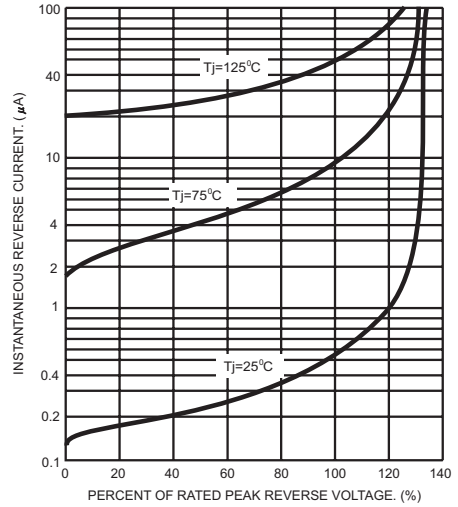


FIG.3- MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

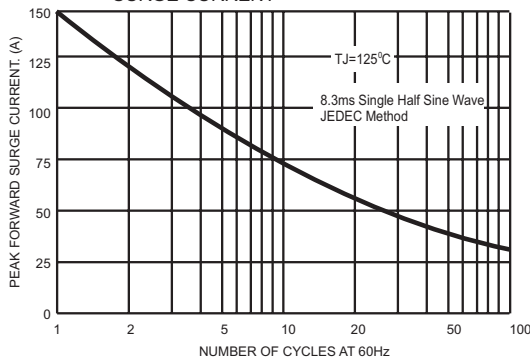


FIG.5- TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

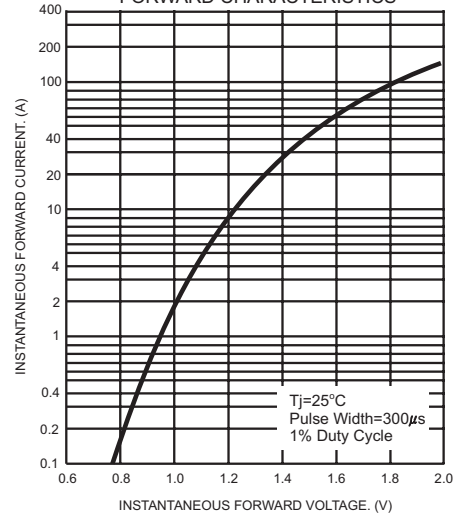


FIG.4- TYPICAL JUNCTION CAPACITANCE

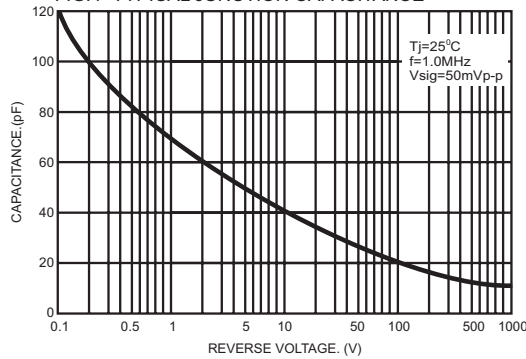


FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

